

Complementary Trench MOSFET

AO6604 (KO6604)

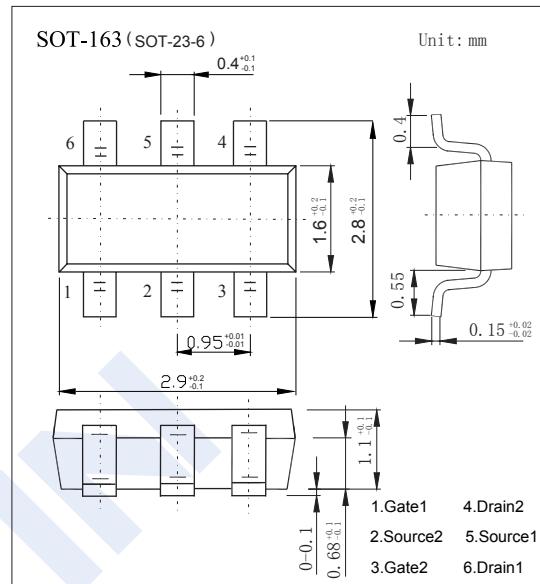
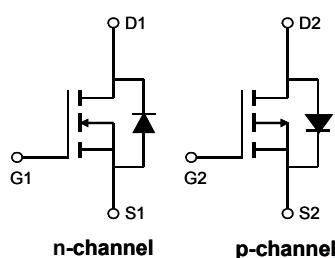
■ Features

- N-Channel: $V_{DS}=20V$ $I_D=3.4A$

$$\begin{aligned}R_{DS(ON)} &< 65m\Omega \quad (V_{GS} = 4.5V) \\R_{DS(ON)} &< 75m\Omega \quad (V_{GS} = 2.5V) \\R_{DS(ON)} &< 100m\Omega \quad (V_{GS} = 1.8V)\end{aligned}$$

- P-Channel: $V_{DS}=-20V$ $I_D=-2.5A$

$$\begin{aligned}R_{DS(ON)} &< 75m\Omega \quad (V_{GS} = -4.5V) \\R_{DS(ON)} &< 95m\Omega \quad (V_{GS} = -2.5V) \\R_{DS(ON)} &< 115m\Omega \quad (V_{GS} = -1.8V)\end{aligned}$$

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V_{DS}	20	-20	V	
Gate-Source Voltage	V_{GS}	± 8			
Continuous Drain Current $T_a = 25^\circ C$	I_D	3.4	-2.5	A	
		2.5	-2		
Pulsed Drain Current	I_{DM}	13	-13	W	
Power Dissipation $T_a = 25^\circ C$	P_D	1.1			
		0.7			
Thermal Resistance.Junction- to-Ambient Steady-State	R_{thJA}	110		$^\circ C/W$	
		150			
Thermal Resistance.Junction- to-Lead Steady-State	R_{thJL}	80			
Junction Temperature	T_J	150			
Storage Temperature Range	T_{stg}	-55 to 150		$^\circ C$	

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■ N-Channel Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250 μA, V _{GS} =0V	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V		1		μA
		V _{DS} =20V, V _{GS} =0V, T _J =55°C		5		
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±8V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250 μA	0.4	0.7	1	V
Static Drain-Source On-Resistance	R _{DSON}	V _{GS} =4.5V, I _D =3.4A		51	65	mΩ
		V _{GS} =4.5V, I _D =3.4A T _J =125°C		68	85	
		V _{GS} =2.5V, I _D =3A		58	75	
		V _{GS} =1.8V, I _D =2A		68	100	
On State Drain Current	I _{D(ON)}	V _{GS} =4.5V, V _{DS} =5V	13			A
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =3.4A		16		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =10V, f=1MHz	205	260	320	pF
Output Capacitance	C _{oss}		33	48	63	
Reverse Transfer Capacitance	C _{rss}		16	27	38	
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f=1MHz	1.5	3	4.5	Ω
Total Gate Charge (4.5V)	Q _g	V _{GS} =4.5V, V _{DS} =10V, I _D =3.4A		2.9	3.8	nC
Gate Source Charge	Q _{gs}			0.4		
Gate Drain Charge	Q _{gd}			0.6		
Turn-On Delay Time	t _{d(on)}	V _{GS} =5V, V _{DS} =10V, R _L =2.95 Ω, R _G =3 Ω		2.5		ns
Turn-On Rise Time	t _r			3.2		
Turn-Off Delay Time	t _{d(off)}			21		
Turn-Off Fall Time	t _f			3		
Body Diode Reverse Recovery Time	t _{rr}			14	19	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 3.4A, dI/dt= 100A/ μs		3.8		nC
Maximum Body-Diode Continuous Current	I _s				1.5	A
Diode Forward Voltage	V _{SD}	I _s =1A, V _{GS} =0V		0.7	1	V

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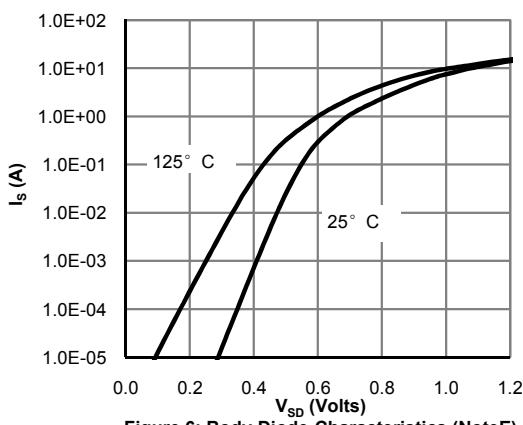
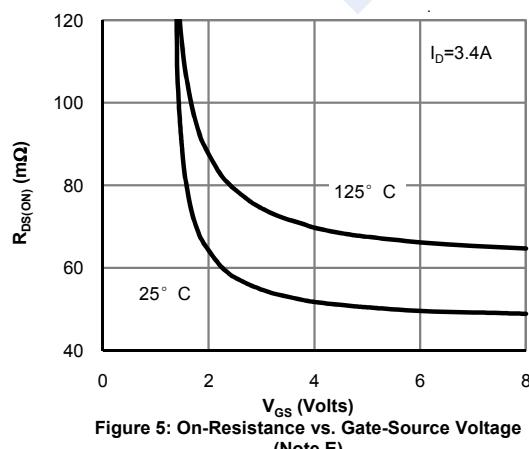
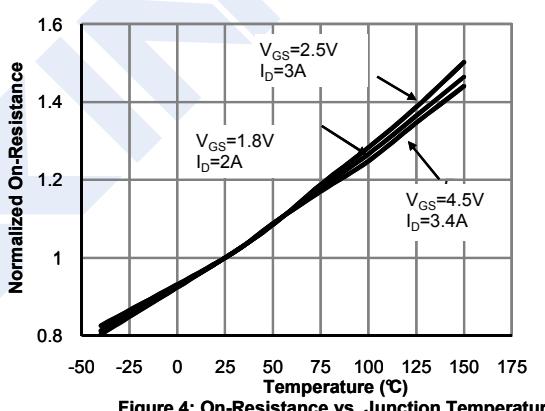
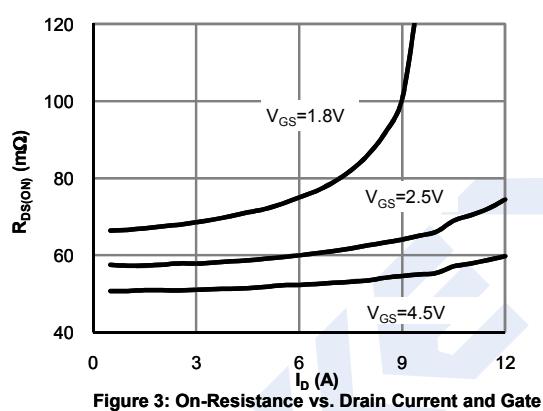
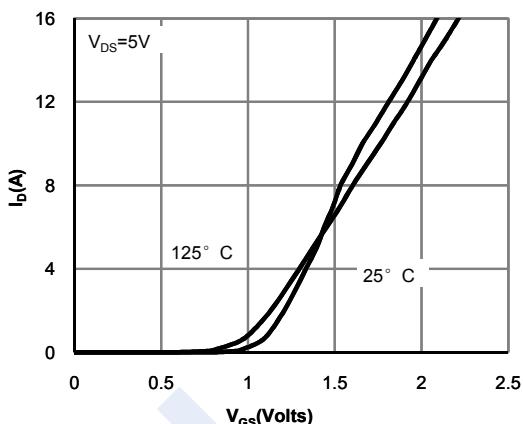
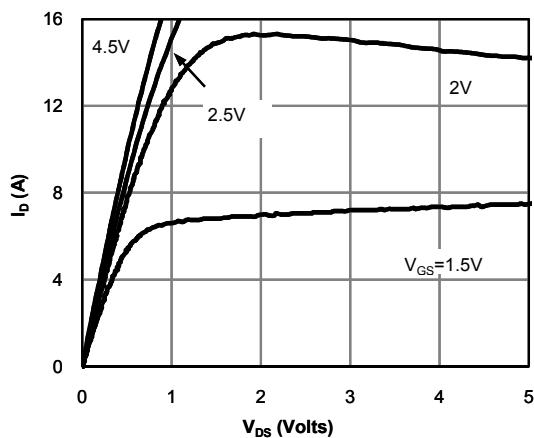
■ P-Channel Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	I _D =-250 μ A, V _{GS} =0V	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DSS} =-20V, V _{GS} =0V			-1	μ A
		V _{DSS} =-20V, V _{GS} =0V, T _J =55°C			-5	
Gate-Body leakage current	I _{GSS}	V _{DSS} =0V, V _{GS} =±8V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DSS} =V _{GS} I _D =-250 μ A	-0.4	-0.65	-1	V
Static Drain-Source On-Resistance	R _{D(on)}	V _{GS} =-4.5V, I _D =-2.5A		56	75	mΩ
		V _{GS} =-4.5V, I _D =-2.5A T _J =125°C		80	105	
		V _{GS} =-2.5V, I _D =-2A		70	95	
		V _{GS} =-1.8V, I _D =-1A		85	115	
On state drain current	I _{D(on)}	V _{GS} =-4.5V, V _{DSS} =-5V	-13			A
Forward Transconductance	g _{FS}	V _{DSS} =-5V, I _D =-2.5A		13		S
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DSS} =-10V, f=1MHz		560	745	pF
Output Capacitance	C _{oss}			80		
Reverse Transfer Capacitance	C _{rss}			70		
Gate resistance	R _G	V _{GS} =0V, V _{DSS} =0V, f=1MHz		15	23	Ω
Total Gate Charge (4.5V)	Q _g	V _{GS} =-4.5V, V _{DSS} =-10V, I _D =-2.5A		8.5	11	nC
Gate Source Charge	Q _{gs}			1.2		
Gate Drain Charge	Q _{gd}			2.1		
Turn-On DelayTime	t _{d(on)}			7.2		ns
Turn-On Rise Time	t _r	V _{GS} =-4.5V, V _{DSS} =-10V, R _L =4 Ω ,R _{GEN} =6 Ω		36		
Turn-Off DelayTime	t _{d(off)}			53		
Turn-Off Fall Time	t _f			56		
Body Diode Reverse Recovery Time	t _{rr}	I _F =-2.5A, dI/dt=100A/μ s		37	49	nC
Body Diode Reverse Recovery Charge	Q _{rr}			27		
Maximum Body-Diode Continuous Current	I _s				-1.5	A
Diode Forward Voltage	V _{SD}	I _s =-1A, V _{GS} =0V		-0.7	-1	V

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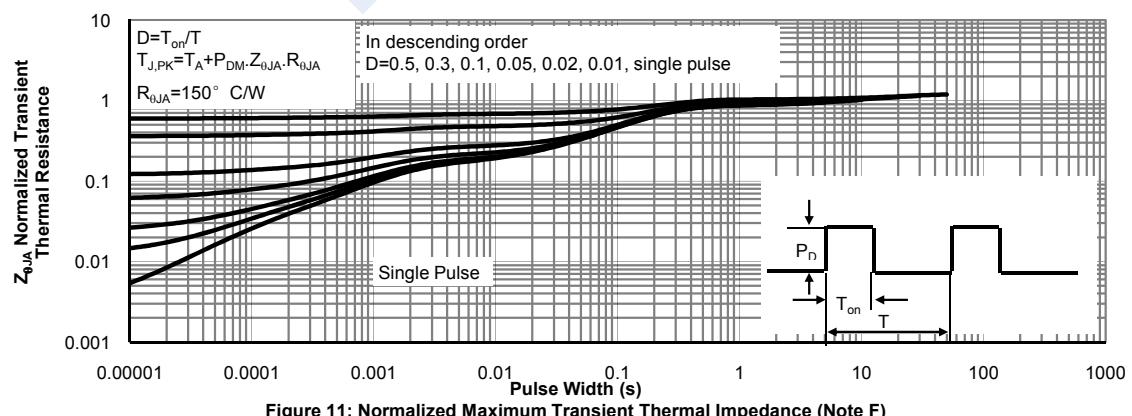
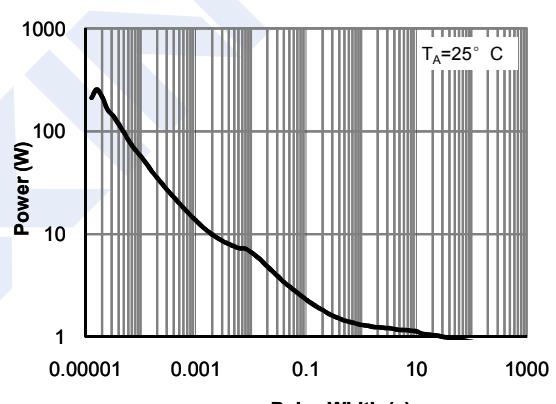
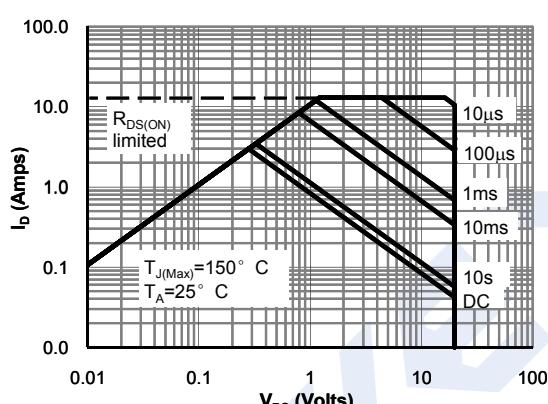
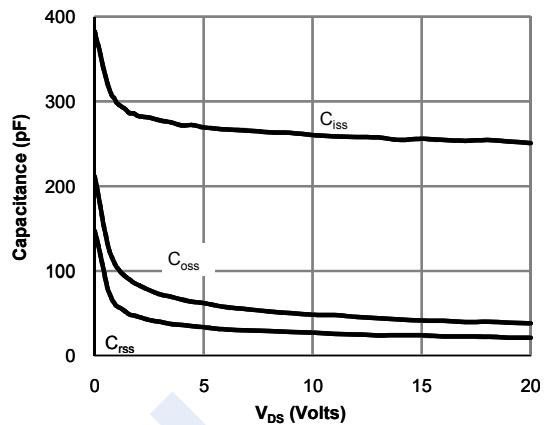
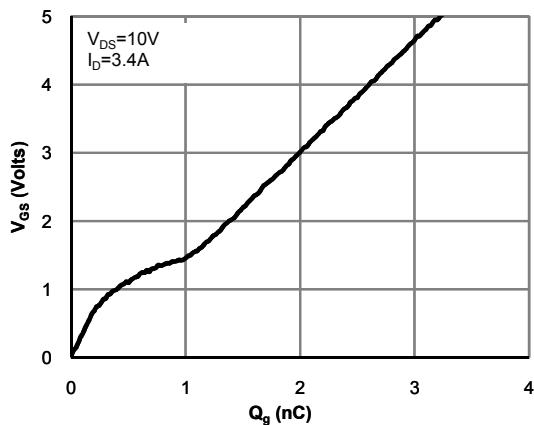
■ N-Channel Typical Characteristics



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■ N-Channel Typical Characteristics



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■ P-Channel Typical Characteristics

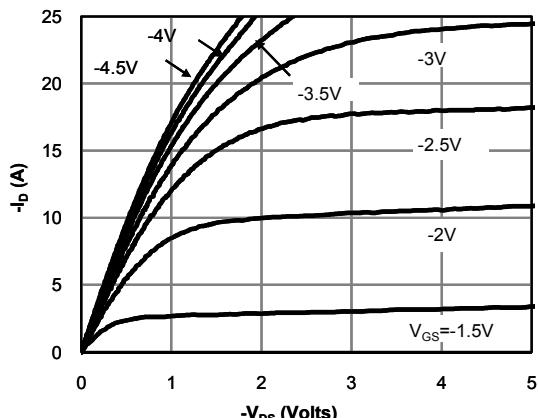


Fig 1: On-Region Characteristics (Note E)

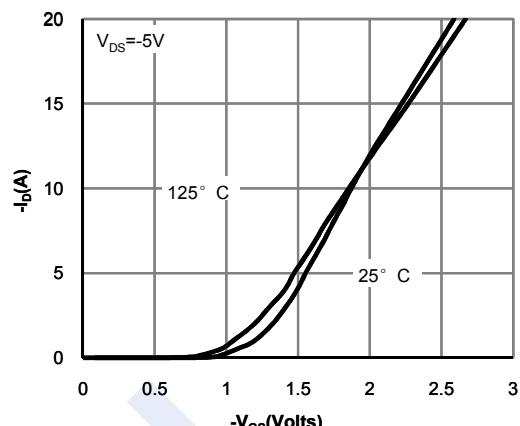


Figure 2: Transfer Characteristics (Note E)

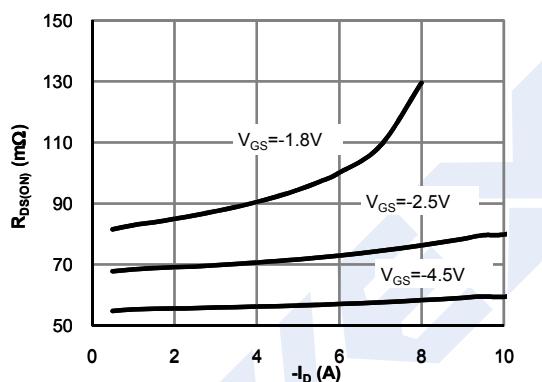


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

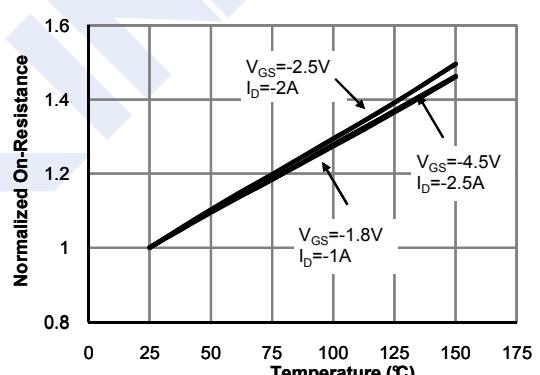


Figure 4: On-Resistance vs. Junction Temperature (Note E)

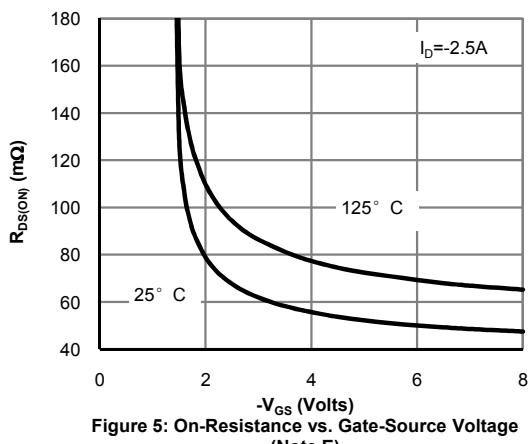


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

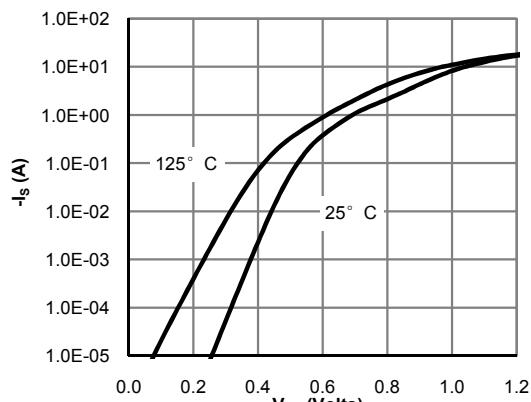


Figure 6: Body-Diode Characteristics (Note E)

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■ P-Channel Typical Characteristics

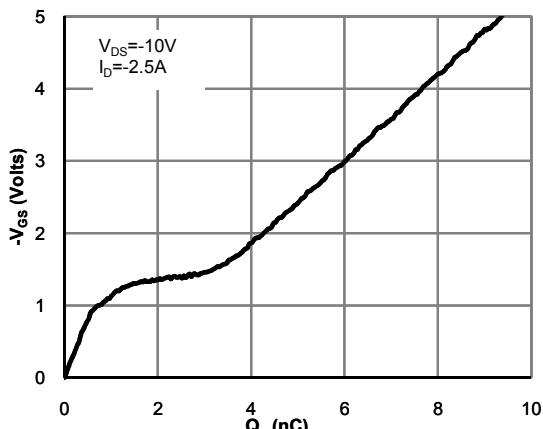


Figure 7: Gate-Charge Characteristics

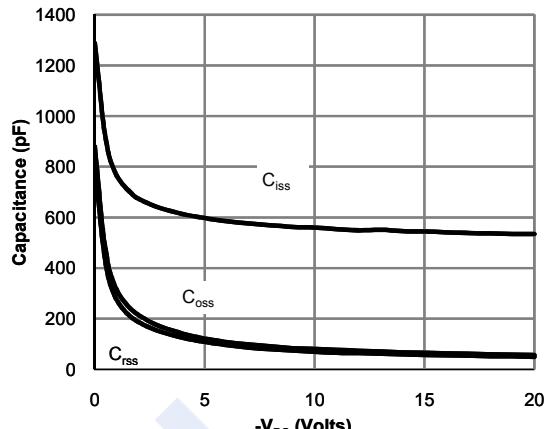


Figure 8: Capacitance Characteristics

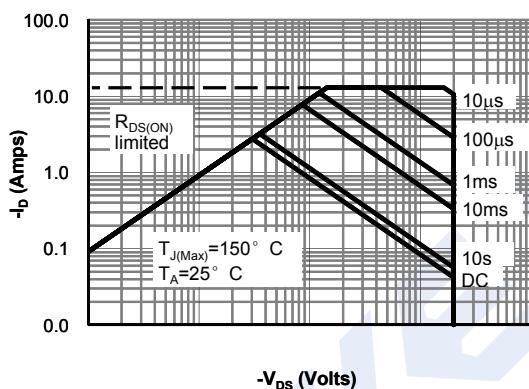


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

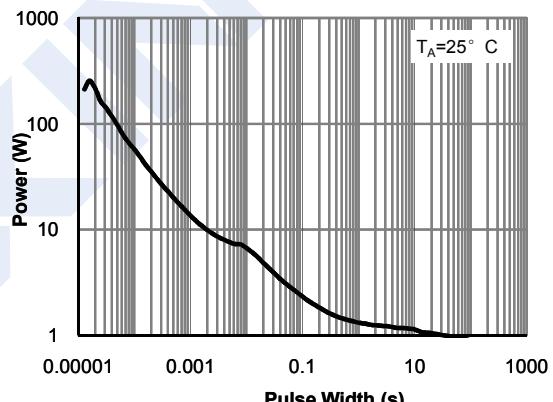


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

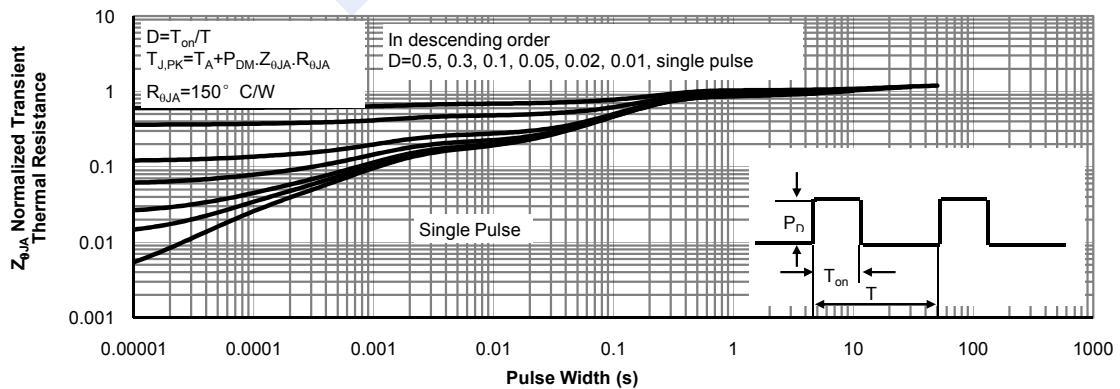


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)